

Emerging trends in laminate & prepreg for high-speed/low-loss-, automotive- and mil/aero designs

27 March 2018, Crowne Plaza Hotel Tel Aviv

Agenda

9.15am	Registration & Coffee	
9.45am	Welcome	Roberto Tulman, Deputy CEO, CTO Eltek
10.00am	Introduction Ventec	Tamara den Daas, GAM Ventec
10.30am	tec-speed® and low loss portfolio	Bill Wang, Technical Director Ventec
11.15am	Coffee break	
11.30am	Polyimide & high reliability	Bill Wang, Technical Director Ventec
12.15pm	Lunch	
13.15pm	ULDK for high speed low loss designs	Martin Cotton, OEM Marketing & Technology Ventec
14.00 pm	Thin flex capabilities	Thomas Michels, MD Europe Ventec
14.30 pm	Thermal Management	Didier Mauve, Marketing & Sales director Ventec
15.00pm	Coffee	
15.15pm	Roundtable Q & A	Ventec all
15.45pm	Closing remarks	Roberto Tulman, Deputy CEO, CTO Eltek
16.00pm	Networking: Wine, Beer & Sandwiches	